



40V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D T _A = +25°C
40V	24mΩ @V _{GS} = 10V	9.0A
400	$32m\Omega @V_{GS} = 4.5V$	7.8A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Motor Control
- Backlighting
- Power Management Functions
- DC-DC Converters

Features

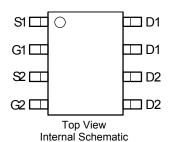
- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

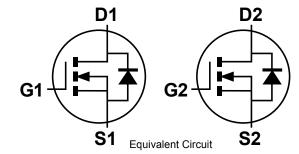
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram below
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (approximate)









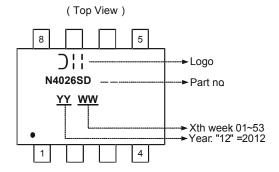
Ordering Information (Note 4 & 5)

Part Number	Compliance	Case	Packaging
DMN4026SSD-13	Standard	SO-8	2,500/Tape & Reel
DMN4026SSDQ-13	Automotive	SO-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_grade_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V_{DSS}	40	V
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Prain Current (Note 7) V = 10V	Steady State	T _A = +25°C T _A = +70°C	I _D	7.0 5.6	А
Continuous Drain Current (Note 7) V _{GS} = 10V	T<10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	9.0 7.2	А
Maximum Continuous Body Diode Forward Current (Note 7)			I _S	2.5	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	70	A

Thermal Characteristics

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 6)	T _A = +25°C	D	1.3	W	
Total Fower Dissipation (Note 6)	T _A = +70°C	P_{D}	0.8	VV	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	98	°C/W	
Thermal Resistance, Junction to Ambient (Note 0)	t<10s	$R_{\theta JA}$	59		
Total Power Dissipation (Note 7)	T _A = +25°C	D-	1.8	W	
Total Fower Dissipation (Note 1)	T _A = +70°C	P_{D}	1.1		
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	D	71		
Thermal Resistance, Junction to Ambient (Note 1)	t<10s	$R_{\theta JA}$	43	°C/W	
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	11.8		
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C	

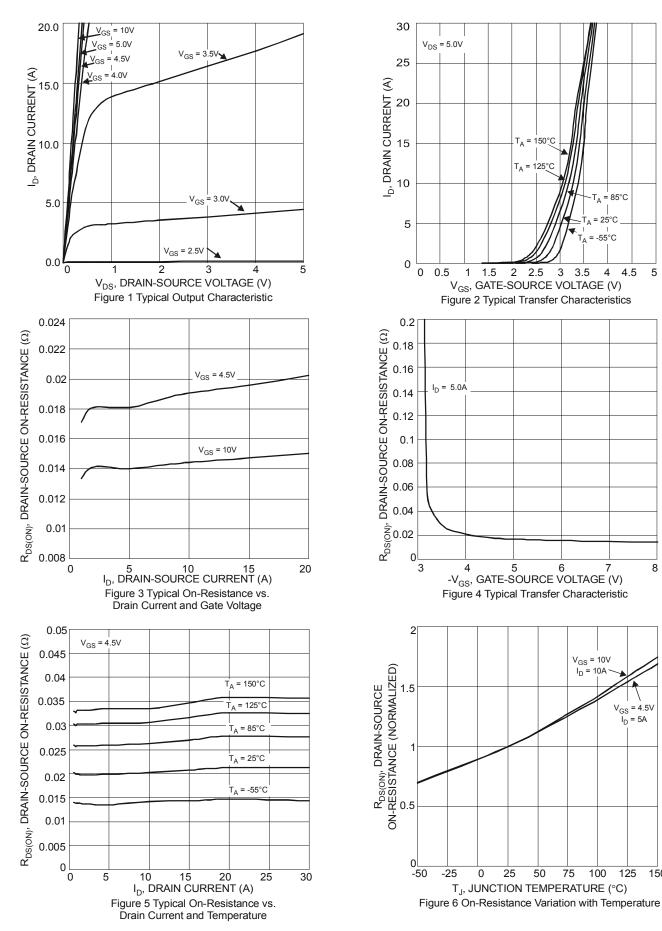
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 40V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	$V_{GS(th)}$	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	D	_	15	24	mΩ	V _{GS} = 10V, I _D = 6A	
Static Dialii-Source Oil-Resistance	R _{DS(ON)}	_	20	32	11122	$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.0	V	V _{GS} = 0V, I _S = 1.0A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	1060	_		V _{DS} = 20V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	84	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	58	_			
Gate Resistance	R_G	_	1.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	8.8	20		V _{DS} = 20V, I _D = 8A	
Total Gate Charge (V _{GS} = 10V)	Q_g	_	19.1	43	nC		
Gate-Source Charge	Q_{gs}	_	3.0	7.5	iiC		
Gate-Drain Charge	Q_{gd}	_	2.5	6			
Turn-On Delay Time	t _{D(on)}		5.3	_		$V_{DD} = 25V, R_L = 2.5\Omega$ $V_{GS} = 10V, R_G = 3\Omega$	
Turn-On Rise Time	t _r	_	7.1	_	nS		
Turn-Off Delay Time	t _{D(off)}	_	15.1	_	113		
Turn-Off Fall Time	t _f	_	4.8	_			
Body Diode Reverse Recovery Time	t _{rr}	_	10.5	_	nS	I _F = 8A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Qrr		4.15	_	nC	$I_F = 8A$, di/dt = 100A/ μ s	

Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- ${\bf 8.\ Short\ duration\ pulse\ test\ used\ to\ minimize\ self-heating\ effect.}$
- 9. Guaranteed by design. Not subject to product testing.

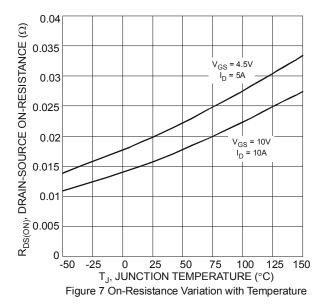


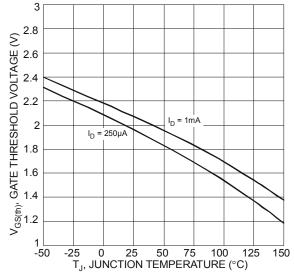


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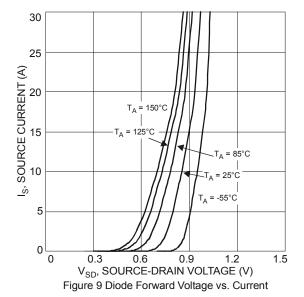
V_{GS} = 4.5V I_D = 5A

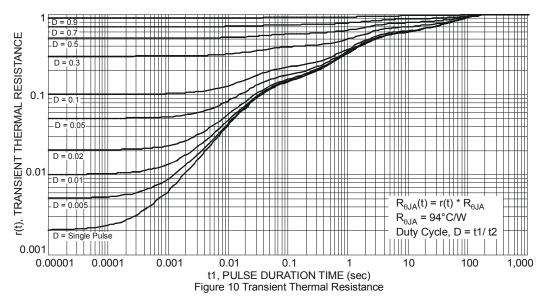








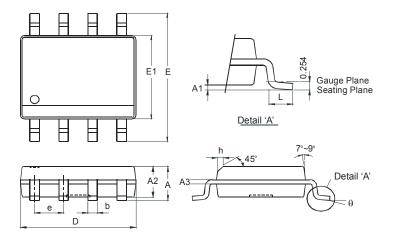






Package Outline Dimensions

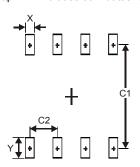
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8				
Dim	Min	Max		
Α	1	1.75		
A1	0.10	0.20		
A2	1.30	1.50		
A3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
Е	5.90	6.10		
E1	3.85	3.95		
е	1.27 Typ			
h	1	0.35		
L	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Χ	0.60
Υ	1.55
C1	5.4
C2	1 27



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